

Evaluation Board: Wide Vin Synchronous Buck DC/DC Converter with Integrated FET

BD9V101MUF-EVK-001 (5.0V | 1.0A Output)

BD9V100MUF-EVK-001 (5.0V | 1.0A Output)

User's Guide

<High Voltage Safety Precautions>

Read all safety precautions before use

Please note that this document covers only the BD9V101/100MUF evaluation board (BD9V10xMUF-EVK-001) and its functions. For additional information, please refer to the datasheet.

To ensure safe operation, please carefully read all precautions before handling the evaluation board



Depending on the configuration of the board and voltages used,

Potentially lethal voltages may be generated.

Therefore, please make sure to read and observe all safety precautions described in the red box below.

Before Use

- Verify that the parts/components are not damaged or missing (i.e. due to the drops).
- [2] Check that there are no conductive foreign objects on the board.
- [3] Be careful when performing soldering on the module and/or evaluation board to ensure that solder splash does not occur.
- [4] Check that there is no condensation or water droplets on the circuit board.

During Use

- [5] Be careful to not allow conductive objects to come into contact with the board.
- [6] Brief accidental contact or even bringing your hand close to the board may result in discharge and lead to severe injury or death.

Therefore, DO NOT touch the board with your bare hands or bring them too close to the board. In addition, as mentioned above please exercise extreme caution when using conductive tools such as tweezers and screwdrivers.

- [7] If used under conditions beyond its rated voltage, it may cause defects such as short-circuit or, depending on the circumstances, explosion or other permanent damages.
- [8] Be sure to wear insulated gloves when handling is required during operation.

After Use

- [9] The ROHM Evaluation Board contains the circuits which store the high voltage. Since it stores the charges even after the connected power circuits are cut, please discharge the electricity after using it, and please deal with it after confirming such electric discharge.
- [10] Protect against electric shocks by wearing insulated gloves when handling.

This evaluation board is intended for use only in research and development facilities and should by handled **only by qualified personnel familiar with all safety and operating procedures.**

We recommend carrying out operation in a safe environment that includes the use of high voltage signage at all entrances, safety interlocks, and protective glasses.

<u>www.rohm.com</u> HVA01E



ROHM Switching Regulator Solutions

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Introduction

This application note will provide the steps necessary to operate and evaluate ROHM's synchronous buck DC/DC converter using the BD9V10xMUF-EVK-001 evaluation board. This includes information for both EVK part numbers, BD9V101MUF-EVK-001 and BD9V10xMUF-EVK-001. Component selection, operating procedures, and application data are included.

Description

BD9V10xMUF-LB is a current mode synchronous buck converter that uses high voltage rated POWER MOSFETs. It features a wide range input voltage range of 16V to 60V and utilizes a very short minimum pulse width (down to 20ns) which enables direct conversion from 60V power supply to 3.3V at 2.1MHz operation. Additionally, this product is part of the *LB family line of products, which means ROHM guarantees long lifetime support of this product specifically for industrial market applications.

Applications

Industrial Equipment Consumer Supplies

Evaluation Board Operating Limits and Absolute Maximum Ratings

Parameter		Symbol	Limit			11	Conditions
			MIN	TYP	MAX	Unit	Conditions
Supply Volta	ge (Absolute N	laximum Rati	ngs)				
Е	BD9V10xMUF	Vin	-0.3	-	70	V	
Supply Volta	ge (Recommer	nded Operatin	g Conditio	ns)			
E	BD9V10xMUF	V _{IN}	16		60	V	
Output Volta	ge / Current			•		•	
В	BD9V10xMUF- EVK-001	Vout	-	5.0	-	V	
		I _{OUT}	-	-	1.0	Α	

Evaluation Board

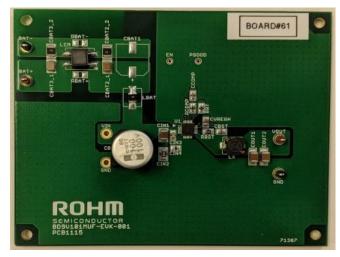


Fig 1: BD9V10xMUF-EVK-001 Evaluation Board

Evaluation Board Schematic

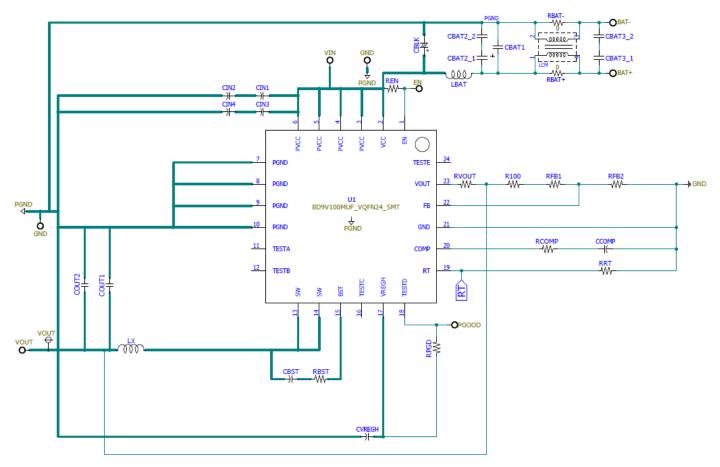


Fig 2: BD9V10xMUF-EVK-001 Evaluation Board Schematic

Evaluation Reference Application Circuit

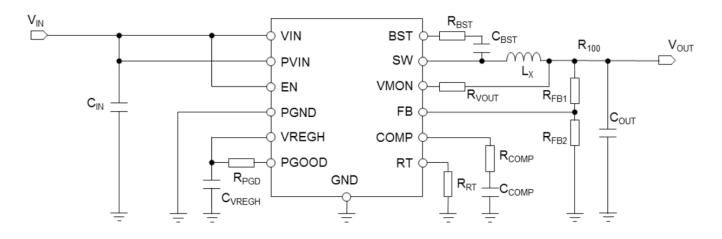


Fig 3: BD9V10xMUF Reference Application Circuit

Special Evaluation Board Notes

Note that this EVK uses some additional components when compared against the reference application circuit (primarily the additional filter and capacitors on the input side). These were added to this EVK to pass the CISPR22 radiated emissions test. If this is not a concern for your application, these external components may be omitted from your final design to required board space and external components.

Evaluation Board Operating Procedure

- 1. This EVK does not have any switches or settings to configure. So, to operate, user just needs to apply the input voltage (between 16 and 60V) to the BAT+ and BAT- terminals of the board.
- 2. NOTE: Do not hot plug a power supply to this device. This can cause overshoot spikes to the input side of the board and the over voltage could potentially destroy some components
- 3. There is an enable pin available on this IC; however, it is connected to Vin using the REN resistor jumper. If you want to test with an MCU or other control signal, please note that high level voltage will turn the device on (>2.5V) and low level voltage will turn the device off (<0.8V)

Reference Application Data

For additional device performance graphs, please refer to the IC's datasheet at the following link: http://rohmfs.rohm.com/en/products/databook/datasheet/ic/power/switching_regulator/bd9v101muf-lb-e.pdf

Evaluation Board BOM

Below is a table showing the Bill of Materials. Part numbers and suppliers are included.

Item	Qty	Reference	Part	Description	Manufacturer	MFG1_PART#
1	2	BAT- (PGND3), GND (TP12)	Black TP	TEST POINT PC MINI .040"D BLACK	Keystone Electronics	5001
2	2	BAT+ (BAT), VOUT (TP5)	RED TP	TEST POINT PC MINI .040"D RED	Keystone Electronics	5000
3	1	CBAT1	DNP	N/A	DNP	DNP
4	1	CBAT2_1	GCM32DC72A475KE02L	CAP CER 4.7UF 100V X7S 1210	MURATA	GCM32DC72A475KE02L
5	1	CBAT3_1	GRM32QR73A682KW01L	CAP CER 6800PF 1KV X7R 1210	MURATA	GRM32QR73A682KW01L
6	3	CBAT3_2, CBAT2_2	SHORT	RES SMD 0 OHM JUMPER 1/4W 1206	YAGEO	AC1210JR-070RL
7	1	CBLK	EMVY101ARA101MKE0S	CAP ALUM 100UF 20% 100V SMD	United Chemi-Con	EMVY101ARA101MKE0S
8	1	CBST	GCM188R71H223K	0603 0.022uF 50volts X7R +/-10%	MURATA	GCM188R71H223K
9	1	ССОМР	GCM188R71H102K	0603 1000pF 50volts X7R 10%	MURATA	GCM188R71H102K
10	1	CIN1	UMK325B7475MMHT	1210 4.7uF 50volts X7R 10%	TAIYO YUDEN	UMK325B7475MMHT
11	1	CIN2	SHORT	RES SMD 0 OHM JUMPER 1/4W 1206	PANASONIC	ERJ-8GEYOROOV
12	1	CIN3	GCM188R71H104K	0603 0.1uF 50volts X7R 10%	MURATA	
13	2	COUT1, COUT2	CGA6P1X7R1C226M250AC	1210 22uF 16volts X7R 10%	TDK	CGA6P1X7R1C226M250AC
14	1	CVREGH	GCM21BR71C225K	0805 2.2uF 16volts X7R 10%	MURATA	GCM21BR71C225K
15	1	LBAT	RC2010JK-070RL	Needs Short, 2010 sized	YAGEO	RC2010JK-070RL
16	1	LCM	PLT5BPH2014R4SNL	CMC 2.4A 2LN 2000HM SMD AEC-Q200	MURATA	PLT5BPH2014R4SNL
17	1	LX	4.7uH	FIXED IND 4.7UH 3.3A 30 MOHM SMD	TDK	CLF6045NIT-4R7N-D
18	3	R100, REN, CIN4	0, SHORT	JUMPER 5% 1/10W 0603	ROHM	TRR03EZPJ000
19	2	RBAT+, RBAT-	DNP	N/A	DNP	DNP
20	1	RBST	3.3	3.3 OHM 5% 1/8W 0805	ROHM	MCR10ERTJ3R3
21	1	RCOMP	51k	51k OHM 0.5% 0.1W 0603	PANASONIC	ERJ-PB3D5102V
22	1	RFB1	43k	43k OHM 0.5% 0.1W 0603	SUSUMU	RR0816P-433-D
23	1	RFB2	8.2k	8.2k OHM 0.5% 0.1W 0603	PANASONIC	ERJ-PB3D8201V
24	1	RPGD	100k	100k OHM 0.5% 0.1W 0603	PANASONIC	ERJ-PB3D1003V
25	1	RRT	7.5k	7.5k OHM 0.5% 0.1W 0603	PANASONIC	ERJ-PB3D7501V
26	1	RVOUT	2k	2k OHM 0.5% 0.1W 0603	ROHM	ERJ-PB3D2001V
27	1	U1	BD9V101MUF (on BD9V101MUF-EVK-001) or BD9V100MUF (on BD9V100MUF-EVK-001)	Buck Converter	ROHM	BD9V101MUF-LBE2 BD9V100MUF-CE2

Fig 4: BD9V10xMUF-EVK-001 EVK BOM

Evaluation Board Layout Information

Material: FR-4

Board Thickness: 1.6mm

• Copper Thickness: 1oz

Board Size: 80mm x 100mm

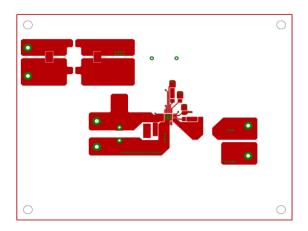
Minimum Copper Width: 0.15mm

• Minimum Air Gap: 0.15mm

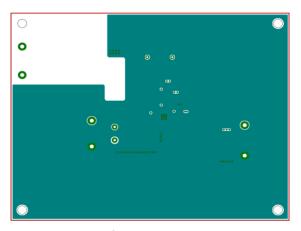
• Minimum Hold Gap: 0.3mm



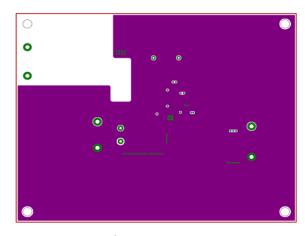
TOP VIEW



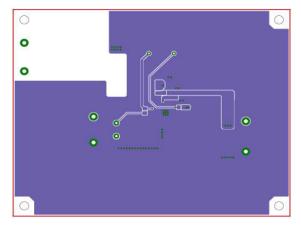
TOP LAYER



2nd LAYER



3rd LAYER



BOTTOM LAYER